

IRF450 JANTX2N6770 JANTXV2N6770

REPETITIVE AVALANCHE AND dv/dt RATED HEXFET®TRANSISTORS THRU-HOLE (TO-204AA)

500V, N-CHANNEL

Product Summary

Part Number	BV _{DSS}	RDS(on)	I _D
IRF450	500V	0.400Ω	12A



Description

HEXFET® MOSFET technology is the key to IR Hirel advanced line of power MOSFET transistors. The efficient geometry and unique processing of this latest "State of the Art" design achieves: very low on-state resistance combined with high trans conductance; superior reverse energy and diode recovery dv/dt capability.

The HEXFET transistors also feature all of the well established advantages of MOSFETs such as voltage control, very fast switching and temperature stability of the electrical parameters. They are well suited for applications such as switching power supplies, motor controls, inverters, choppers, audio amplifiers and high energy pulse circuits.

Features

- Repetitive Avalanche Ratings
- Dynamic dv/dt Rating
- · Hermetically Sealed
- Simple Drive Requirements
- ESD Rating: Class 3A per MIL-STD-750, Method 1020

Absolute Maximum Ratings

Symbol	Parameter	Value	Units	
I _{D1} @ V _{GS} = 10V, T _C = 25°C	Continuous Drain Current	12		
I _{D2} @ V _{GS} = 10V, T _C = 100°C	Continuous Drain Current	7.75	Α	
I _{DM} @T _C = 25°C	Pulsed Drain Current ①	48		
P _D @T _C = 25°C	Maximum Power Dissipation	150	W	
	Linear Derating Factor	1.2	W/°C	
V_{GS}	Gate-to-Source Voltage	± 20	V	
E _{AS}	Single Pulse Avalanche Energy ②	ergy ② 8.0		
I _{AR}	Avalanche Current ①	12	Α	
E _{AR}	Repetitive Avalanche Energy ①	15	mJ	
dv/dt	Peak Diode Recovery 3	3.5	V/ns	
T _J	Operating Junction and	-55 to + 150		
T _{STG}	Storage Temperature Range	-95 to + 150	°C	
	Lead Temperature	300 (0.063 in. (1.6mm) from case for 10s)		
	Weight	11.5 (Typical)	g	

For footnotes refer to the page 2.



Electrical Characteristics @ Tj = 25°C (Unless Otherwise Specified)

Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions
BV _{DSS}	Drain-to-Source Breakdown Voltage	500			V	$V_{GS} = 0V, I_{D} = 1.0mA$
$\Delta BV_{DSS}/\Delta T_{J}$	Breakdown Voltage Temp. Coefficient		0.78		V/°C	Reference to 25°C, I _D = 1.0mA
R _{DS(on)}	Static Drain-to-Source On-Resistance			0.4	0	V _{GS} = 10V, I _{D2} = 7.75A ④
	Static Drain-to-Source On-Resistance			0.5	Ω	V _{GS} = 10V, I _{D1} = 12A ④
$V_{GS(th)}$	Gate Threshold Voltage	2.0		4.0	V	$V_{DS} = V_{GS}$, $I_D = 250\mu A$
Gfs	Forward Transconductance	5.5			S	$V_{DS} = 15V, I_{D2} = 7.75A$ @
I _{DSS}	Zero Gate Voltage Drain Current			25	μA	$V_{DS} = 400V, V_{GS} = 0V$
	Zero Gate Voltage Drain Gurrent			250	μΛ	$V_{DS} = 400V, V_{GS} = 0V, T_{J} = 125^{\circ}C$
I _{GSS}	Gate-to-Source Leakage Forward			100	nA	$V_{GS} = 20V$
	Gate-to-Source Leakage Reverse			-100	117 ($V_{GS} = -20V$
Q_G	Total Gate Charge	55		120		I _{D1} = 12A
Q_{GS}	Gate-to-Source Charge	5.0		19	nC	V _{DS} = 250V
Q_{GD}	Gate-to-Drain ('Miller') Charge	27		70		V _{GS} = 10V
t _{d(on)}	Turn-On Delay Time			35		V _{DD} = 250V
tr	Rise Time			190	20	I _{D1} = 12A
$t_{d(off)}$	Turn-Off Delay Time			170	ns	$R_G = 2.35\Omega$
t _f	Fall Time			130		V _{GS} = 10V
Ls +L _D	Total Inductance		6.1		nH	Measured from Drain lead (6mm / 0.25 in from package) to Source lead (6mm/ 0.25 in from package)
C _{iss}	Input Capacitance		2700			V _{GS} = 0V
Coss	Output Capacitance		600		pF	V _{DS} = 25V
C_{rss}	Reverse Transfer Capacitance		240			f = 1.0MHz

Source-Drain Diode Ratings and Characteristics

Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions
Is	Continuous Source Current (Body Diode)			12	۸	
I _{SM}	Pulsed Source Current (Body Diode) ①			48	Α	
V_{SD}	Diode Forward Voltage			1.7	V	$T_J = 25^{\circ}C, I_S = 12A, V_{GS} = 0V$
t _{rr}	Reverse Recovery Time			1600	ns	$T_J = 25^{\circ}C, I_F = 12A, V_{DD} \le 30V$
Q_{rr}	Reverse Recovery Charge			14	μC	di/dt = 100A/μs ④
t _{on}	Forward Turn-On Time	Intrins	ic turn-c	n time i	s negligib	le (turn-on is dominated by L _S +L _D)

Thermal Resistance

Symbol	Parameter	Min.	Тур.	Max.	Units	
$R_{\theta JC}$	Junction-to-Case			0.83	°C/M	
$R_{ heta JA}$	Junction-to-Ambient (Typical socket mount)			30	°C/W	

Footnotes:

- ① Repetitive Rating; Pulse width limited by maximum junction temperature.
- $^{\circ}$ V_{DD} = 50V, starting T_J = 25°C, L= 0.111mH, Peak I_L = 12A, V_{GS} = 10V.
- $\ \ \,$ $\ \ \,$ $\ \ \,$ $I_{SD} \ \le \ 12A,$ di/dt $\ \ \,$ $\ \ \,$ $130A/\mu s,$ $V_{DD} \ \le \ 500V,$ $T_{J} \ \le \ 150^{\circ}C.$ Suggested R_{G} =2.35 Ω

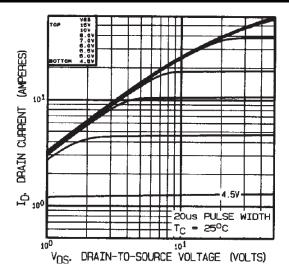


Fig 1. Typical Output Characteristics

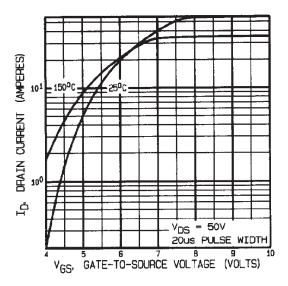


Fig 3. Typical Transfer Characteristics

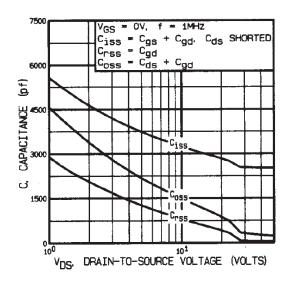


Fig 5. Typical Capacitance Vs. Drain-to-Source Voltage

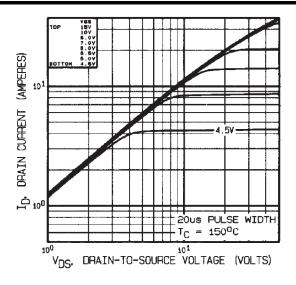


Fig 2. Typical Output Characteristics

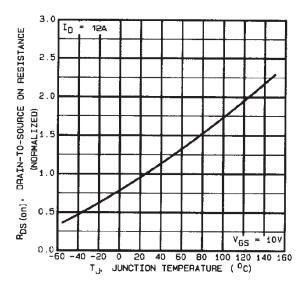


Fig 4. Normalized On-Resistance Vs. Temperature

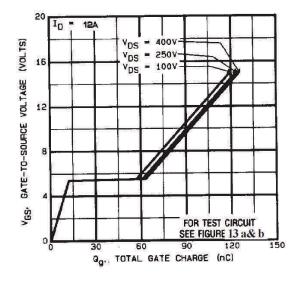


Fig 6. Typical Gate Charge Vs. Gate-to-Source Voltage

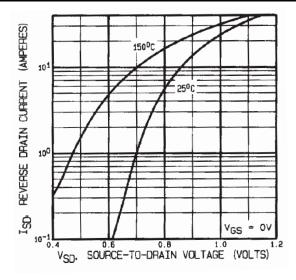


Fig 7. Typical Source-Drain Diode Forward Voltage

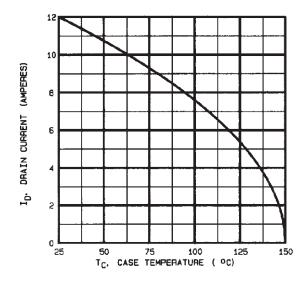


Fig 9. Maximum Drain Current Vs. Case Temperature

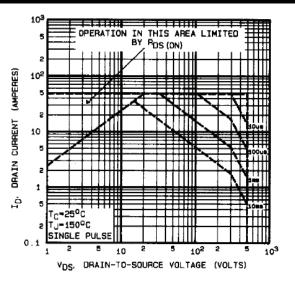


Fig 8. Maximum Safe Operating Area

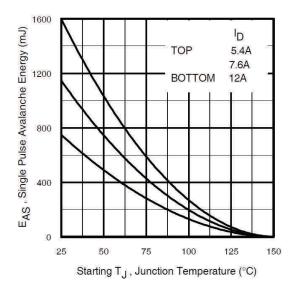


Fig 10. Maximum Avalanche Energy Vs. Drain Current

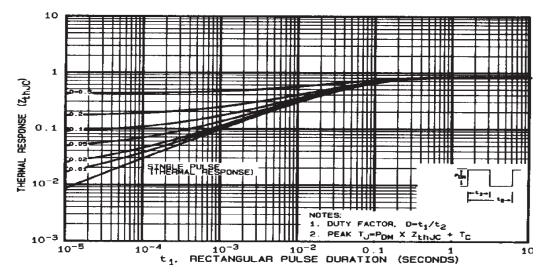


Fig 11. Maximum Effective Transient Thermal Impedance, Junction-to-Case

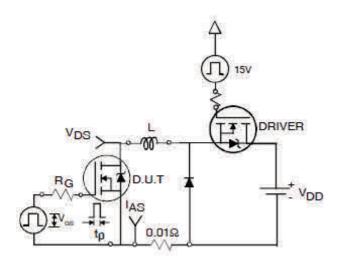


Fig 12a. Unclamped Inductive Test Circuit

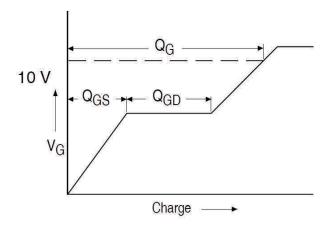


Fig 13a. Gate Charge Waveform

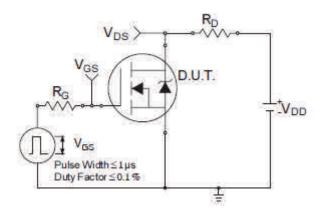


Fig 14a. Switching Time Test Circuit

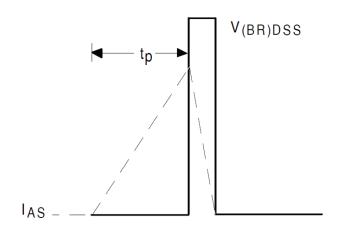


Fig 12b. Unclamped Inductive Waveforms

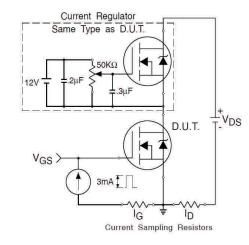


Fig 13b. Gate Charge Test Circuit

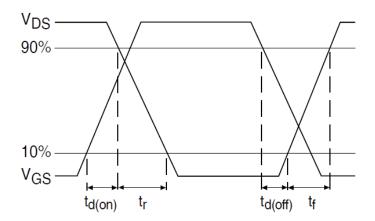
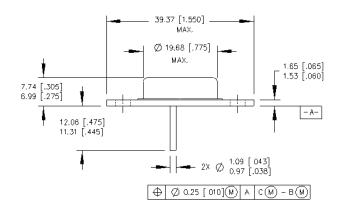
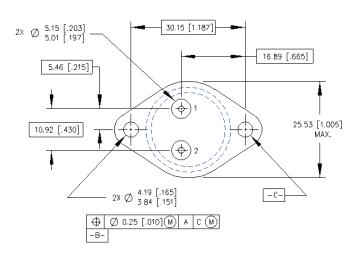


Fig 14b. Switching Time Waveforms



Case Outline and Dimensions - TO-204AA (Modified TO-3)





PIN ASSIGNMENTS

HEXFET SCHOTTKY IGBT 1 - SOURCE 1 - ANODE 1 1 - GATE 2 - GATE 3 - DRAIN (CASE) 2 - EMITTER 3 - COLLECTOR (CASE) 2 - ANODE 2 3 - COMMON CATHOD (CASE)

NOTES:

- 1. DIMENSIONING & TOLERANCING PER ANSI Y14.5M 1982.
- 2. CONTROLLING DIMENSION: INCH.
- DIMENSIONS ARE SHOWN IN MILIMETERS [INCHES]
 OUTLINE CONFORMS TO JEDEC OUTLINE TO -204-AA



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